

Dr.R K Sinha inaugurates the HDI Facility

Dr.Ratan Kumar Sinha, Director, BARC and Member Atomic Energy Commission inaugurated **High Density Interconnect (HDI) Printed Circuit Board** Facility on 20th December 2010. This is one of the four (4) Infrastructure Projects conceived and supported by BARC for upgrading the facilities at ECIL. As a result, the processes is enhanced and our capacity to manufacture multi-layer PCBs upto 16 layers with a minimum trace width/spacing of 3 mil. It is also planned to cater to the requirements of flex- rigid PCBs.

The objective behind this facility is primarily to meet the exacting requirements of clients in strategic sectors viz., Nuclear, Defence, Aerospace and Security.

The facility has an installed capacity of 500 Sq.mts. per year.

The facility is already certified for ISO 9001 Quality Management System